# **BCD-To-Seven Segment Latch/Decoder/Driver**

# **CMOS MSI (Low-Power Complementary MOS)**

The MC14513B BCD-to-seven segment latch/decoder/driver is constructed with complementary MOS (CMOS) enhancement mode devices and NPN bipolar output drivers in a single monolithic structure. The circuit provides the functions of a 4-bit storage latch, an 8421 BCD-to-seven segment decoder, and has output drive capability. Lamp test ( $\overline{\text{LT}}$ ), blanking ( $\overline{\text{BI}}$ ), and latch enable (LE) inputs are used to test the display, to turn-off or pulse modulate the brightness of the display, and to store a BCD code, respectively. The Ripple Blanking Input (RBI) and Ripple Blanking Output (RBO) can be used to suppress either leading or trailing zeroes. It can be used with seven–segment light emitting diodes (LED), incandescent, fluorescent, gas discharge, or liquid crystal readouts either directly or indirectly.

Applications include instrument (e.g., counter, DVM, etc.) display driver, computer/calculator display driver, cockpit display driver, and various clock, watch, and timer uses.

- Low Logic Circuit Power Dissipation
- High-current Sourcing Outputs (Up to 25 mA)
- Latch Storage of Binary Input
- Blanking Input
- · Lamp Test Provision
- Readout Blanking on all Illegal Input Combinations
- Lamp Intensity Modulation Capability
- Time Share (Multiplexing) Capability
- Adds Ripple Blanking In, Ripple Blanking Out to MC14511B
- Supply Voltage Range = 3.0 V to 18 V
- Capable of Driving Two Low–Power TTL Loads, One Low–power Schottky TTL Load to Two HTL Loads Over the Rated Temperature Range.

#### MAXIMUM RATINGS\* (Voltages Referenced to VSS)

Rating	Symbol	Value	Unit
DC Supply Voltage	$V_{DD}$	- 0.5 to + 18	V
Input Voltage, All Inputs	V <sub>in</sub>	$-0.5$ to $V_{DD} + 0.5$	V
DC Current Drain per Input Pin	I	10	mA
Operating Temperature Range	TA	- 55 to + 125	°C
Power Dissipation, per Package†	PD	500	mW
Storage Temperature Range	T <sub>stg</sub>	- 65 to + 150	°C
Maximum Continuous Output Drive Current (Source) per Output	l <sub>OHmax</sub>	25	mA
Maximum Continuous Output Power (Source) per Output ‡	POHmax	50	mW

POHmax = IOH (VDD - VOH)

Plastic "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C Ceramic "L" Packages: – 12 mW/°C From 100°C To 125°C

## MC14513B



L SUFFIX CERAMIC CASE 726

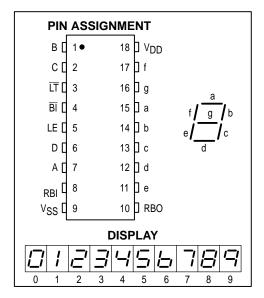


P SUFFIX PLASTIC CASE 707

#### ORDERING INFORMATION

MC14XXXBCP MC14XXXBCL Plastic Ceramic

 $T_A = -55^{\circ}$  to 125°C for all packages.



#### TRUTH TABLE

	Inputs							Outputs								
RBI	LE	ВІ	LΤ	D	С	В	Α	RBO	а	b	С	d	е	f	g	Display
Х	Х	Х	0	Х	Χ	Χ	Х	+	1	1	1	1	1	1	1	8
Х	Х	0	1	Х	Х	Χ	Х	+	0	0	0	0	0	0	0	Blank
1	0	1	1	0	0	0	0	1	0	0	0	0	0	0	0	Blank
0	0	1	1	0	0	0	0	0	1	1	1	1	1	1	0	0
Х	0	1	1	0	0	0	1	0	0	1	1	0	0	0	0	1
X	0	1	1	0	0	1	0	0	1	1	0	1	1	0	1	2
X	0	1	1	0	0	1	1	0	1	1	1	1	0	0	1	
X	0	1	1	0	1	0	0	0	0	1	1	0	0	1	1	4
Х	0	1	1	0	1	0	1	0	1	0	1	1	0	1	1	5
Х	0	1	1	0	1	1	0	0	0	1	0	1	1	1	1	6
X	0	1	1	0	1	1	1	0	1	1	1	0	0	0	0	7
X	0	1	1	1	0	0	0	0	1	1	1	1	1	1	1	8
X	0	1	1	1	0	0	1	0	1	1	1	1	0	1	1	9
Х	0	1	1	1	0	1	0	0	0	0	0	0	0	0	0	Blank
Х	0	1	1	1	0	1	1	0	0	0	0	0	0	0	0	Blank
X	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	Blank
Х	0	1	1	1	1	0	1	0	0	0	0	0	0	0	0	Blank
X	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	Blank
X	0	1	1	1	1	1	1	0	0	0	0	0	0	0	0	Blank
Х	1	1	1	Х	Χ	Χ	Χ	†				*				*

X = Don't Care

†RBO = RBI ( $\overline{D} \ \overline{C} \ \overline{B} \ \overline{A}$ ), indicated by other rows of table

\*Depends upon the RCD code previously applied when I F = 0



<sup>\*</sup> Maximum Ratings are those values beyond which damage to the device may occur.

<sup>†</sup>Temperature Derating:

**ELECTRICAL CHARACTERISTICS** (Voltages Referenced to V<sub>SS</sub>)

Characteristic			۷ <sub>DD</sub>	- 55°C			25°C		125		
		Symbol	Vdc	Min	Max	Min	Typ #	Max	Min	Max	Unit
Output Voltage — Segmen $V_{in} = V_{DD}$ or 0	t Outputs "0" Level	VOL	5.0 10 15		0.05 0.05 0.05	_ _ _	0 0 0	0.05 0.05 0.05		0.05 0.05 0.05	Vdc
$V_{in} = 0$ or $V_{DD}$	"1" Level	Voн	5.0 10 15	4.1 9.1 14.1	_ _ _	4.1 9.1 14.1	5.0 10 15	_ _ _	4.1 9.1 14.1	_ _ _	Vdc
Output Voltage — RBO Ou $V_{in} = V_{DD} \text{ or } 0$	tput "0" Level	V <sub>OL</sub>	5.0 10 15		0.05 0.05 0.05		0 0 0	0.05 0.05 0.05		0.05 0.05 0.05	Vdc
$V_{in} = 0$ or $V_{DD}$	"1" Level	VOH	5.0 10 15	4.95 9.95 14.95	_ _ _	4.95 9.95 14.95	5.0 10 15	_ _ _	4.95 9.95 14.95	_ _ _	Vdc
Input Voltage # (V <sub>O</sub> = 3.8 or 0.5 Vdc) (V <sub>O</sub> = 8.8 or 1.0 Vdc) (V <sub>O</sub> = 13.8 or 1.5 Vdc)	"0" Level	V <sub>IL</sub>	5.0 10 15	_ _ _	1.5 3.0 4.0	_ _ _	2.25 4.50 6.75	1.5 3.0 4.0	_ _ _	1.5 3.0 4.0	Vdc
$(V_O = 0.5 \text{ or } 3.8 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 8.8 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.8 \text{ Vdc})$	"1" Level	VIH	5.0 10 15	3.5 7.0 11	_ _ _	3.5 7.0 11	2.75 5.50 8.25	_ _ _	3.5 7.0 11	_ _ _	Vdc
Output Drive Voltage — Se $(I_{OH} = 0 \text{ mA})$ $(I_{OH} = 5.0 \text{ mA})$ $(I_{OH} = 10 \text{ mA})$ $(I_{OH} = 15 \text{ mA})$ $(I_{OH} = 20 \text{ mA})$ $(I_{OH} = 25 \text{ mA})$	egments Source	Voн	5.0	4.1 — 3.9 — 3.4 —		4.1 — 3.9 — 3.4 —	4.57 4.24 4.12 3.94 3.70 3.54	  -  -  -  -	4.1 — 3.5 — 3.0 —	  -  -  -  -	Vdc
$(I_{OH} = 0 \text{ mA})$ $(I_{OH} = 5.0 \text{ mA})$ $(I_{OH} = 10 \text{ mA})$ $(I_{OH} = 15 \text{ mA})$ $(I_{OH} = 20 \text{ mA})$ $(I_{OH} = 25 \text{ mA})$			10	9.1 — 9.0 — 8.6 —	  -  -  -  -	9.1 — 9.0 — 8.6 —	9.58 9.26 9.17 9.04 8.90 8.75	_ _ _ _ _	9.1 — 8.6 — 8.2 —	_ _ _ _ _	Vdc
$(I_{OH} = 0 \text{ mA})$ $(I_{OH} = 5.0 \text{ mA})$ $(I_{OH} = 10 \text{ mA})$ $(I_{OH} = 15 \text{ mA})$ $(I_{OH} = 20 \text{ mA})$ $(I_{OH} = 25 \text{ mA})$			15	14.1 — 14 — 13.6 —		14.1 — 14 — 13.6 —	14.59 14.27 14.18 14.07 13.95 13.80	   	14.1 — 13.6 — 13.2 —	   	Vdc

(continued)

This device contains protection circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. A destructive high current mode may occur if  $V_{in}$  and  $V_{out}$  is not constrained to the range  $V_{SS} \le (V_{in} \text{ or } V_{out}) \le V_{DD}$ .

Due to the sourcing capability of this circuit, damage can occur to the device if V<sub>DD</sub> is applied, and the outputs are shorted to V<sub>SS</sub> and are at a logical 1 (See Maximum Ratings).

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V<sub>SS</sub> or V<sub>DD</sub>).

 $\textbf{ELECTRICAL CHARACTERISTICS} - \textbf{continued} \hspace{0.1cm} (\textit{Voltages Referenced to V}_{SS})$ 

		V <sub>DD</sub>	- 5	5°C	25°C			125	5°C	
Characteristic	Symbol	Vdc	Min	Max	Min	Typ #	Max	Min	Max	Unit
Output Drive Current — RBO Output (V <sub>OH</sub> = 2.5 V) Source (V <sub>OH</sub> = 9.5 V) (V <sub>OH</sub> = 13.5 V)	Іон	5.0 10 15	- 0.40 - 0.21 - 0.81	_ _ _	- 0.32 - 0.17 - 0.66	- 0.64 - 0.34 - 1.30	_ _ _	- 0.22 - 0.12 - 0.46	_ _ _	mAdc
(V <sub>OL</sub> = 0.4 V) Sink (V <sub>OL</sub> = 0.5 V) (V <sub>OL</sub> = 1.5 V)	lOL	5.0 10 15	0.18 0.47 1.80	_ _ _	0.15 0.38 1.50	0.29 0.75 2.90	_ _ _	0.10 0.26 1.0	_ _ _	mAdc
Output Drive Current — Segments (V <sub>OL</sub> = 0.4 V) Sink (V <sub>OL</sub> = 0.5 V) (V <sub>OL</sub> = 1.5 V)	lOL	5.0 10 15	0.64 1.6 4.2	_ _ _	0.51 1.3 3.4	0.88 2.25 8.8	_ _ _	0.36 0.9 2.4		mAdc
Input Current	l <sub>in</sub>	15	_	± 0.1	_	±0.00001	± 0.1	_	± 1.0	μAdc
Input Capacitance	C <sub>in</sub>	_	_	_	_	5.0	7.5	_	_	pF
Quiescent Current (Per Package) V <sub>in</sub> = 0 or V <sub>DD</sub> , I <sub>out</sub> = 0 μA	I <sub>DD</sub>	5.0 10 15	_ _ _	5.0 10 20	_ _ _	0.005 0.010 0.015	5.0 10 20	_ _ _	150 300 600	μAdc
Total Supply Current**†  (Dynamic plus Quiescent, Per Package)  (C <sub>L</sub> = 50 pF on all outputs, all buffers switching)	lΤ	5.0 10 15	$I_T = (1.9 \mu\text{A/kHz})  \text{f} + I_{DD}$ $I_T = (3.8 \mu\text{A/kHz})  \text{f} + I_{DD}$ $I_T = (5.7 \mu\text{A/kHz})  \text{f} + I_{DD}$							μAdc

#Noise immunity specified for worst-case input combination.

Noise Margin for both "1" and "0" level =

1.0 Vdc min @  $V_{DD} = 5.0 \text{ Vdc}$ 

2.0 Vdc min @ V<sub>DD</sub> = 10 Vdc

2.5 Vdc min @ V<sub>DD</sub> = 15 Vdc

†To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + 3.5 \times 10^{-3} (C_L - 50) \text{ V}_{DD}f$$

where: I<sub>T</sub> is in μA (per package), C<sub>L</sub> in pF, V<sub>DD</sub> in Vdc, and f in kHz is input frequency.

Input LE and RBI low, and Inputs D,  $\overline{BI}$  and  $\overline{LT}$  high. f in respect to a system clock. All outputs connected to respective  $C_L$  loads.

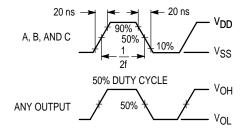


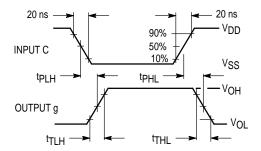
Figure 1. Dynamic Power Dissipation Signal Waveforms

<sup>\*\*</sup> The formulas given are for the typical characteristics only at 25°C.

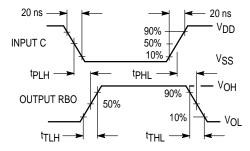
# SWITCHING CHARACTERISTICS\* ( $C_L$ = 50 pF, $T_A$ = 25°C)

		V <sub>DD</sub>				
Characteristic	Symbol	Vdc	Min	Тур	Max	Unit
Output Rise Time — Segment Outputs	tтьн	5.0 10 15	=	40 30 25	80 60 50	ns
Output Rise Time — RBO Output	tтLН	5.0 10 15		480 240 190	960 480 380	ns
Output Fall Time — Segment Outputs* $t_{THL} = (1.5 \text{ ns/pF}) \text{ C}_{L} + 50 \text{ ns}$ $t_{THL} = (0.75 \text{ ns/pF}) \text{ C}_{L} + 37.5 \text{ ns}$ $t_{THL} = (0.55 \text{ ns/pF}) \text{ C}_{L} + 37.5 \text{ ns}$	<sup>†</sup> THL	5.0 10 15	=	125 75 65	250 150 130	ns
Output Fall Time — RBO Outputs $t_{THL} = (3.25 \text{ ns/pF}) \text{ C}_{L} + 107.5 \text{ ns}$ $t_{THL} = (1.35 \text{ ns/pF}) \text{ C}_{L} + 67.5 \text{ ns}$ $t_{THL} = (0.95 \text{ ns/pF}) \text{ C}_{L} + 62.5 \text{ ns}$	tтнL	5.0 10 15	=	270 135 110	540 270 220	ns
Propagation Delay Time — A, B, C, D Inputs* $t_{PLH} = (0.40 \text{ ns/pF}) C_L + 620 \text{ ns}$ $t_{PLH} = (0.25 \text{ ns/pF}) C_L + 237.5 \text{ ns}$ $t_{PLH} = (0.20 \text{ ns/pF}) C_L + 165 \text{ ns}$	<sup>t</sup> PLH	5.0 10 15	=	640 250 175	1280 500 350	ns
$t_{PHL} = (1.3 \text{ ns/pF}) C_L + 655 \text{ ns}$ $t_{PHL} = (0.60 \text{ ns/pF}) C_L + 260 \text{ ns}$ $t_{PHL} = (0.35 \text{ ns/pF}) C_L + 182.5 \text{ ns}$	<sup>t</sup> PHL	5.0 10 15	_ _ _	720 290 200	1440 580 400	ns
Propagation Delay Time — RBI and $\overline{BI}$ Inputs* $tp_{LH} = (1.05 \text{ ns/pF}) C_L + 547.5 \text{ ns}$ $tp_{LH} = (0.45 \text{ ns/pF}) C_L + 177.5 \text{ ns}$ $tp_{LH} = (0.30 \text{ ns/pF}) C_L + 135 \text{ ns}$	<sup>t</sup> PLH	5.0 10 15	=	600 200 150	750 300 220	ns
$t_{PHL} = (0.85 \text{ ns/pF}) C_L + 442.5 \text{ ns}$ $t_{PHL} = (0.45 \text{ ns/pF}) C_L + 177.5 \text{ ns}$ $t_{PHL} = (0.35 \text{ ns/pF}) C_L + 142.5 \text{ ns}$	t <sub>PHL</sub>	5.0 10 15	_ _ _	485 200 160	970 400 320	ns
Propagation Delay Time — $\overline{LT}$ Input* $tp_{LH} = (0.45 \text{ ns/pF}) C_L + 290.5 \text{ ns}$ $tp_{LH} = (0.25 \text{ ns/pF}) C_L + 112.5 \text{ ns}$ $tp_{LH} = (0.20 \text{ ns/pF}) C_L + 80 \text{ ns}$	<sup>t</sup> PLH	5.0 10 15	=	313 125 90	625 250 180	ns
$t_{PHL} = (1.3 \text{ ns/pF}) C_L + 248 \text{ ns}$ $t_{PHL} = (0.45 \text{ ns/pF}) C_L + 102.5 \text{ ns}$ $t_{PHL} = (0.35 \text{ ns/pF}) C_L + 72.5 \text{ ns}$	<sup>t</sup> PHL	5.0 10 15	_ _ _	313 125 90	625 250 180	ns
Setup Time	t <sub>su</sub>	5.0 10 15	100 40 30	_ _ _	_ _ _	ns
Hold Time	th	5.0 10 15	60 40 30	_ _ _	_ _ _	ns
Latch Enable Pulse Width	tWL(LE)	5.0 10 15	520 220 130	260 110 65	_ _ _	ns

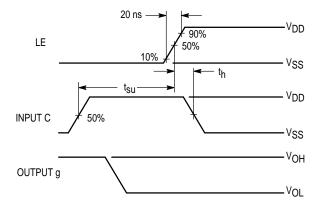
<sup>\*</sup> The formulas given are for the typical characteristics only.



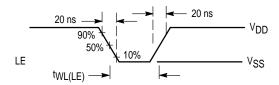
a. Data Propagation Delay: Inputs RBI, D and LE low, and Inputs A, B, BI and LT high.



b. Inputs A, B, D and LE low, and Inputs RBI,  $\overline{\text{BI}}$  and  $\overline{\text{LT}}$  high.



c. Setup and Hold Times: Input RBI and D low, Inputs A, B,  $\overline{\text{BI}}$  and  $\overline{\text{LT}}$  high.

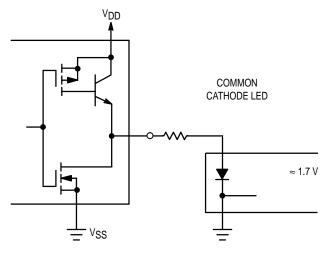


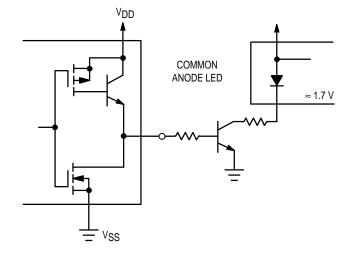
d. Pulse Width: Data DCBA strobed into latches.

Figure 2. Dynamic Signal Waveforms

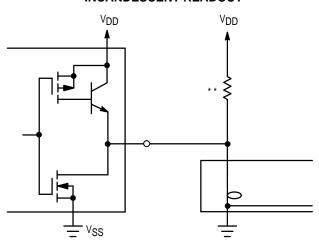
#### **CONNECTIONS TO VARIOUS DISPLAY READOUTS**

### LIGHT EMITTING DIODE (LED) READOUT

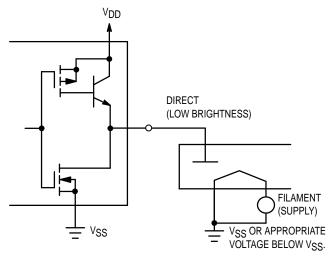




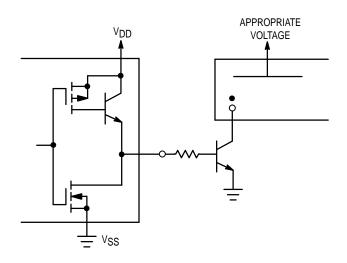
#### **INCANDESCENT READOUT**



#### **FLUORESCENT READOUT**

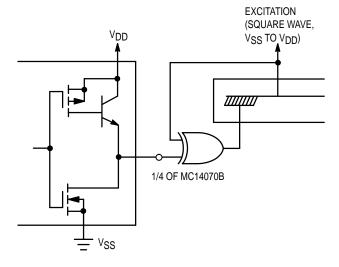


#### **GAS DISCHARGE READOUT**



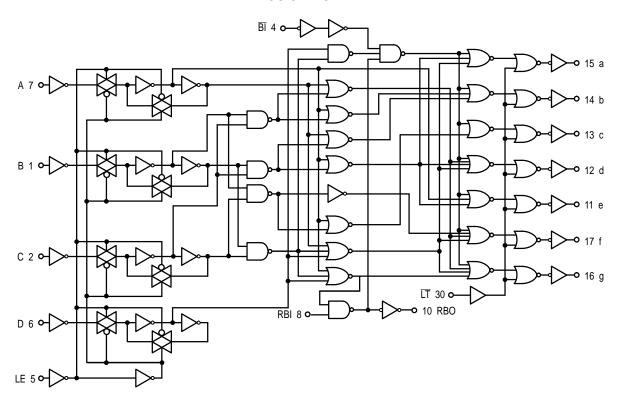
\*\*A filament pre—warm resistor is recommended to reduce filament thermal shock and increase the effective cold resistance of the filament.

## LIQUID CRYSTAL (LC) READOUT



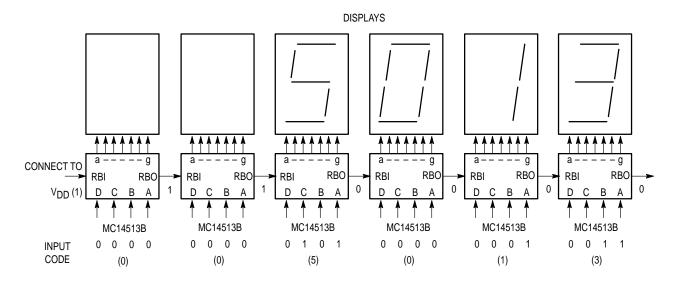
Direct dc drive of LC's not recommended for life of LC readouts.

#### **LOGIC DIAGRAM**



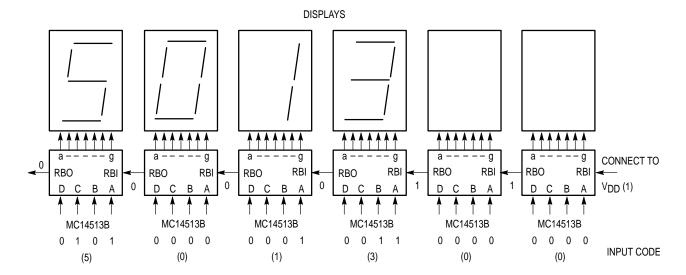
#### TYPICAL APPLICATIONS FOR RIPPLE BLANKING

#### **LEADING EDGE ZERO SUPPRESSION**



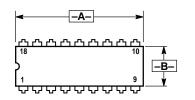
### TYPICAL APPLICATIONS FOR RIPPLE BLANKING (Cont)

#### TRAILING EDGE ZERO SUPPRESSION

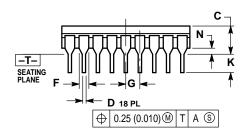


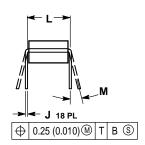
#### **OUTLINE DIMENSIONS**

### **L SUFFIX** CERAMIC DIP PACKAGE CASE 726-04 **ISSUE G**







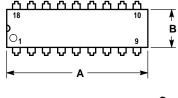


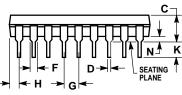
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
   DIMENSION L TO CENTER OF LEAD WHEN
- FORMED PARALLEL.
  DIMENSION F FOR FULL LEADS. HALF LEADS OPTIONAL AT LEAD POSITIONS 1, 9, 10, AND 18.

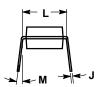
	INC	HES	MILLIN	IETERS		
DIM	MIN	MAX	MIN	MAX		
Α	0.880	0.910	22.35	23.11		
В	0.240	0.295	6.10	7.49		
C	-	0.200		5.08		
D	0.015	0.021	0.38	0.53		
F	0.055	0.070	1.40	1.78		
G	0.100	BSC	2.54 BSC			
J	0.008	0.012	0.20	0.30		
K	0.125	0.170	3.18	4.32		
L	0.300	BSC	7.62	BSC		
М	0°	15°	0°	15°		
N	0.020	0.040	0.51	1.02		

#### **P SUFFIX**

PLASTIC DIP PACKAGE CASE 707-02 **ISSUE C** 







#### NOTES

- 1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER
- 2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL
- 3. DIMENSION B DOES NOT INCLUDE MOLD

	MILLIN	IETERS	S INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	22.22	23.24	0.875	0.915			
В	6.10	6.60	0.240	0.260			
U	3.56	4.57	0.140	0.180			
D	0.36	0.56	0.014	0.022			
F	1.27	1.78	0.050	0.070			
G	2.54	BSC	0.100 BSC				
Н	1.02	1.52	0.040	0.060			
7	0.20	0.30	0.008	0.012			
K	2.92	3.43	0.115	0.135			
L	7.62	BSC	0.300 BSC				
М	0 °	15°	0 °	15°			
N	0.51	1.02	0.020	0.040			

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